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OPTO-ANALOG DEVICES DIVISION ELECTRONIC COMPONENTS GROUP SHARP CORPORATION

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DEVICE SPECIFICA	ATION FOR	16	K sta		lles .	D U	Ben			8.
	OPIC LIGHT DETECTOR	· · ·					•			
MODEL No.	GA1A1S201WP		,			a t A	•	•		
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		•								**

Specified for

Enclosed please find copies of the Specifications which consists of 14 pages including cover. After confirmation of the contents, please be sure to send back ______copy of the Specifications with approving signature on each.

CUSTOMER'S APPROVAL

PRESENTED

DATE

BY K. 0

H. Ogura, Department General Manager of Engineering Dept.,III Opto-Analog Devices Div. ELECOM Group SHARP CORPORATION

DATE

BY

Product name : OPIC LIGHT DETECTOR

Model No.: GA1A1S201WP

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1. Application

This specification applies to the outline and characteristics of Silicon OPIC light detecting device Model No. GA1A1S201WP.

- Outline Refer to the attached drawing No. CY13631L02.
- Ratings and characteristics Refer to the attached sheet, page 4.
- 4. Reliability Refer to the attached sheet, page 5.
- Outgoing inspection Refer to the attached sheet, page 6.
- 6. Supplement
 - (6-1) Circuit block diagram
 - Refer to the attached sheet, page 7.
 - (6-2) Packing specifications shall be refered to attached drawing.
 - (6-3) This product is not designed against electromagnetic and ionized-particle irradiation.
 - (6-4) This product shall not contain the following materials.
 - Also, the following materials shall not be used in the production process for this product.
 - Materials for ODS : CFC_s, Halon, Carbon tetrachloride
 - 1.1.1-Trichloroethane (Methyl chloroform)
 - (6-5) This product does not contain the chemical materials regulated by RoHS.
 - (6-6) This product does not contain specific brominated flame retardants such as the PBB and PBDE.
 - (6-7) Product mass (Piece): Approximately 3.5mg
- 7. Notes
 - (7-1) By-pass capacitors

In order to stabilize power supply line, connect some by-pass capacitors of 0.01μ F or more between Vcc and GND within 5mm from lead pins.

- (7-2) Cleaning conditions :
 - Solvent cleaning : Solvent temperature 45°C or less Immersion for 3 min or less

Ultrasonic cleaning : The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output, cleaning time, PCB size or device mounting condition etc.

- Please test it in actual using condition and confirm that doesn't occur any defect
- before starting the ultrasonic cleaning.
- The cleaning shall be carried out with solvent below.
- Solvent : Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

(7-3) Soldering

(7-3-1) Solder reflow

Please do two times or less soldering at the temperature and the time within the temperature profile in attached sheet-1. (7-3-2) Soldering by hand

To solder onto lead pins, please solder at 320°C for 3 seconds or less using soldering iron 50W or less.

Please be careful not to give the mechanical force to the package when soldering

because it may cause the deformation or defect due to the plated connection.

(7-3-3) Case of other soldering

Other soldering methods such as dip soldering and VPS should not be used. Please use (7-3-1) or (7-3-2).



GND

Io Vcc

3

4



1) Unspecified tolerance shall be ± 0.2 mm.

Scale	Material	Finish		GA1A1S201WP
20/1			Name	Outline Dimensions
Unit	Package : Epoxy resin	Pin: Au plating		
1 = 1 / 1 mm		× ,0	Drawing No.	C'Y'1'3'6'3'1'L'0'2'

3. Ratings and characteristics

3.1	Absolute	maximum	ratings

Absolute maximum ratings			Ta=25°C
Parameter	Symbol	Rating	Unit
Supply voltage	V _{CC}	-0.3 to +7.0	V ,
Output current	Io	1	mA
Operating temperature	T _{Opr}	-40 to +85	°C
Storage temperature	T _{Stg}	-40 to +85	°C
Soldering temperature*	T _{Sol}	250	°C

* Within 10s and two times (MAX) according to the attached reflow profile

3.2 Recommended operating conditions

(Condition: Ta =0 to						
Parameter	Symbol	MIN.	MAX.	Unit		
Operating supply voltage	V _{CC}	2.3	3.2	V		
Dynamic range	D	3	55000	1x		

3.3 Electro-optical characteristics

		the second s	4		Ta=25℃,V	/cc=2.9V
Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Supply current	I _{CC}	E _v =1000lx	40	70	150	μA
	I ₀ 1	Ev=100lx	16	20	24	μA
Output	I _O 2	$E_V = 1000 lx$	27	30	33	μA
current *1,*2	I _O 3	Ev=01x	· · · ·	-	1	μA
Temperature	α1	-30° C - +70°C, E _v =50 to 550001x	-	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	0.25	%/°C
Coefficient	α2	$0^{\circ}C - +50^{\circ}C,$ E _V =50 to 550001x	_	-	0.2	%/°C
Peak sensitivity	λ _P		-	555	ſ	nm
Rise time	tr1	E_V =50 to 550001x	- ·	-	150	us
(10%-90%) *3	tr2	$Ta = -30 \text{ to } +70^{\circ}C$	-		5	ms
Fall time	tfl	E_{V} =50 to 550001x	-		150	us
(10%-90%) *3	tf2	$Ta=0$ to $+50^{\circ}C$	-	-	15	ms
Output current difference	ΔΙ	Io (incandescent lamp E_V =100lx) - Io (fluorescent lamp E_V =100lx) *4	-2	-	2	μA

*1: E_v: Illuminance by CIE standard light source A (tungsten lamp)

*2: Sensor output vs.illuminance is logarithmic.

 $I_0=10 \times \log(Ev)$ (uA)

*3: Illuminance by white LED.

*4: White LED is used on mass production line instead of fluorescent lamp.

4. Reliability

The reliability of products shall satisfy items listed below.

		Confidence LTPD : 1	e level : 90% 0 or 20
Test Items	Test Conditions	Failure Judgment Criteria	Samples (n) Defective(C)
Temperature cycling	1 cycle $-40^{\circ}C \leftrightarrow +85^{\circ}C$ (30min) (30min) 20 cycles test		n=22, C=0
High temp. and high humidity storage	+60°C,90%RH, 500h		n=22, C=0
High temp. storage	+85°C, 500h	$I_{\rm CC} < L \times 0.8$	n=22, C=0
Low temp. storage	- 40°C, 500h	$I_{CC} > U \times 1.2$	n=22, C=0
Operation test	V_{CC} =3.2V, Ta =+25°C, E _V =3000lx 500h	$I_0 1 < L \times 0.8$ $I_0 1 > U \times 1.2$	n=22, C=0
Mechanical shock	1000m/s ² , 6ms, Half sine wave 3 times/ \pm X, \pm Y, \pm Z direction	$I_0 2 < L \times 0.8$ $I_0 2 > U \times 1.2$	n=11, C=0
Variable frequency vibration	200m/s ² 100 to 2000 to 100Hz / Sweep for 4min 48min/X, Y, Z direction	U: Upper specification limit L: Lower specification limit	n=11, C=0
Soldering heat	250°C, 10 s, 2 times The temperature profile is according to the precautions for soldering (attachment-1).		n=11, C=0

5. Outgoing inspection

(1) Inspection lot

Inspection shall be carried out per each delivery lot.

(2) Inspection method

A single sampling plan, normal inspection level II based on ISO2859 shall be adopted.

Parameter		Inspection items and test method							
	1	Disconnection, short							
	Inverse polarity on terminal				ана са				
		Characteristics defect							
		Parameter				Unit			
Major		Parameter	Symbo	MIN.	MAX.				
defect		Consumption current	I _{CC}	40	150	μΑ	0.1		
	3	Output current 1	I ₀ 1	16	24	μA			
		Output current 2	I ₀ 2	27	33	· μ Α ີ			
		Output current 3	I ₀ 3	-	1	μA			
	1								
		Measurement conditions are described	in 3.3.		•				
		Appearance defect		· · · · ·		-			
		Parameter	Parameter Judgment criteria						
		Cmale	and the second	Visible crack i	its				
		Crack position shall be defect.							
Minor									
defect		Split, Chip, Scratch,		One which aff	ects the charac	cteristics	0.25		
4	1.	Stain, Blur		of paragraph 3	.3 shall be def	ect.	0.25		
		Bubble, Foreign matter							
	1	(One on resin surface				n se de la constante Se de la constante de la c			
	1	which can wipe off shall							
		not be applied.)							
	:		1						

6. Supplement

(6-1) Circuit block diagram



(6-2) Output Current Characteristic



4 Packaging

4-1 Inner packing



- ② Inner packing material: Reel(PPE), Carrier tape(PC), Cover tape(PET)
- 3 Quantity: 2,000pcs./reel
- 4-2 Outer packing



- Quantity: 10,000pcs./box
 Indication: Model No., quantity and inspection date
- (5) Regular packaged mass: Approximately 600g

Precautions for Soldering GA1A1S201WP

- 1. In case, solder reflow
 - Please do two times or less soldering at the temperature and the time within the temperature profile as shown in the figure below.



2. Other precautions

An infrared lamp used to heat up for soldering may cause a localized temperature rise in the resin. So keep the package temperature within that specified in Item 1.

Please be careful not to give the mechanical force to the package when soldering

because it may cause the deformation or defect due to the plated connection.

Even if within the temperature profile above, there is the possibility that the gold wire in package is broken in case that the deformation of PCB gives the affection to terminals.

Please use after confirming the conditions fully by actual solder reflow machine.

- 3. Storage and management after open
 - 3.1 Storage condition : Storage shall be in accordance with the below conditions.
 Storage temp. : 5 to 30°C
 Storage humidity : 70%RH or less
 - 3.2 Treatment after open
 - (1) After open, please mount at the conditions of humidity 60%RH or less and temperature 5 to 25% within 3 days.
 - (2) In case of long time storage after open, please mount at the conditions of humidity 70%RH or less and temperature 5 to 30°C within 2 weeks by using dry box (humidity 20% or less, temperature 5 to 25°C) or resealing with desiccant in moisture-proof sack by sealer.
 - 3.3 Baking before mounting
 - In case that it could not be carried out the above treatment, it is able to mount by baking treatment. However baking treatment shall be limited only 1 time.

Recommended conditions : 125°C, 16 to 24 hours Recommended conditions at the packaged condition by the reel : 65°C, 48 hours

X In the case baking at the packaged condition, please hang the reel on the oven using the spindle through the center hall Please do not put the reel across the oven.

Package specifications (ϕ 180mm reel)

1. Application

This specification applies to the taping specifications and the relation items for the GA1A1S201WP.

2. Taping method

- (2.1) Tape structure and Dimensions (Refer to the attached sheet-2-2) The tape shall have a structure in which a cover tape is sealed heat-pressed on the carrier tape made by electrically conductive polycarbonate to protect against static electricity.
- (2.2) Reel structure and Dimensions (Refer to the attached sheet-2-3)

(2.3) Direction of product insertion (Refer to the attached sheet-2-3)Product direction in carrier tape shall direct to the detecting part at the hole side on the tape.

(2-4) Inclusion correction

In case correcting inclusion failing products, these products can be cut out from the carrier tape and the cutting parts can be sealed. At this time, the products are not included at the same places.

3. Adhesiveness of cover tape

The exhalation force between carrier tape and cover tape shall be 0.1N to 1N for the angle from 160° to 180° .

4. Rolling method and quantity

Wind the tape back on the reel so that the cover tape will be outside the tape. Attach more than 16cm of blank tape to the trailer and 40cm to the leader of the tape and fix the both ends with adhesive tape. One reel shall contain 2000 pcs, but in the case products are cut out, the number is less.

5. Marking

The outer packaging case shall be marked with following information.

* Model No. * Number of pieces delivered * Production date

6. Safety protection during shipping

There shall be no deformation of component or degradation of electrical charcteristics due to shipping.

Tape structure and Dimensions



Unit	А	С	D	E	F	G
mm	8. $0^{\pm 0.1}$	$3.5^{\pm0.1}$	$1.75^{\pm0.1}$	$4.0^{\pm 0.1}$	2.0 ± 0.1	$4.0^{\pm0.1}$

Unit	Н	i	J	K	L
mm	$\phi 1.5^{+0.1}$	2. $12^{\pm 0.1}$	$0.25^{\pm0.1}$	$0.70^{\pm 0.1}$	$1.70^{\pm 0.1}$

Reel structure and Dimensions



	and the second second		· · · · · · · · · · · · · · · · · · ·		1997 - A.	
unit symbol	a	b	C C	d	e	f
mm	$180^{\pm 1}$	9.5 ^{± 1}	$60^{\pm 1}$	$13^{\pm 0.2}$	$13.1^{\pm 1}$	$2.0^{\pm 0.5}$

Direction of product insertion



Moisture-proof package specification (ϕ 180mm reel)

1. Application

This specification applies to the products which Sharp delivers to customer.

. Packing specifications

2.1 F	Packaging material			
	Name	Material	Quantity	Aim
	Aluminum laminated bag	Aluminum polyethylene	Refer to 2.2	Moisture-proof
	Label	Paper(-made)	-	Indication of Model No. and Quantity
	Humidity indicator card	Paper(-made)	1 sheet / reel	Indication of Humidity

2.2 Packaging method

- (1) Seal the aluminum laminated bag included the ruled tape-reel and humidity indicator card quantity.
- (2) Fill up the blank of label and paste on the bag.
- (3) Put the moisture-proof laminated bag in the ruled case

Package shape	Product	Ouantity	Moisture-proof sack Quantity
Tape-reel (ϕ 180mm)	1 ch. type	2000pcs. / reel	1reel / bag
			<u> </u>

Minimum order Quantity : 1 reel / bag

(4) Packing case is closed by craft tape and Model No., Quantity, and Inspection date are filled out.
 (Quantity: 10,000pcs./case) *Except the case products by failing to seal are cutout.

SHARP CORPORATION
PARTNO. GA1A1S201WP
EIAJ C-3 bar-code
EIAJC-3 bar-code
<eiaj c-3=""> MADE IN CHINA</eiaj>

3. Storage and management after opening the package

- 3.1 Storage condition : Storage shall be in accordance with the below conditions. Storage temp. : 5 to 30°C
 - Storage humidity : 70%RH or less

3.2 Treatment after opening the package

- (1) After open, please mount at the conditions of humidity 60% RH or less and temperature 5 to 25° C within 3 days.
- (2) In case of long time storage after open, please mount at the conditions of humidity 70%RH or less and temperature 5 to 30°C within 2 weeks by using dry box or resealing with desiccant in moisture-proof sack by sealer.

3.3 Baking before mounting

In case that it could not carry out the above treatment, it is able to mount by baking treatment. However baking treatment shall be limited only 1 time.

Recommended conditions : 125° C, 16 to 24 hours Recommended conditions at the packaged condition by the reel : 65° C, 48 hours

X In the case baking at the packaged condition, please hang the reel on the oven using the spindle through the center hall Please do not put the reel across the oven.